TPS544B20 / TPS544C20

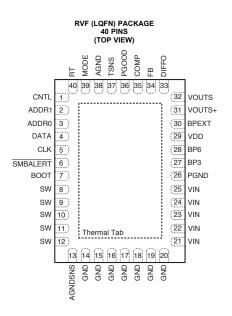
Quick Reference Guide

For more information: www.ti.com/product/TPS544B20 www.ti.com/product/TPS544C20

TEXAS INSTRUMENTS

The SWIFT™ 20-A TPS544B20 and 30-A TPS544C20

non-isolated DC/DC integrated FET converters feature high-frequency operation and fast transient performance in a small 5mm × 7mm package. The PMBus interface offers converter configuration as well as monitoring of key parameters including output voltage, current and an option for external temperature. This quick reference guide is intended to provide key information that is useful during the design, development and support processes. More information is available at: www.ti.com/pmbus



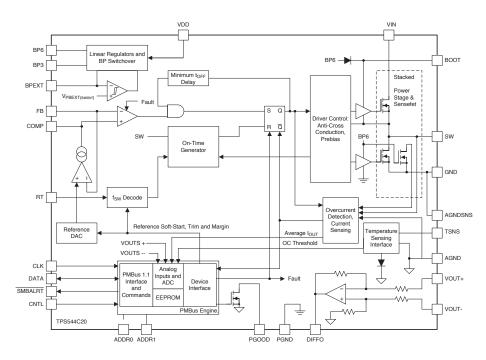


Table 2. Fault Protection Summary

FAULT	VDD UV	UV	ov	HSOC	LSOC	ОТ	TSD (OTFI)		
FAULT CAUSES	1) Input undervoltage 2) Loss of input	1) Output overcurrent 2) Low-side short 3) FB short high	Pre-biased output High-side short FB short to GND	High-side short Output short to GND	1) Low-side short 2) Output overcurrent	High board temperature	High device temperature due to ambient or power dissipation Temperature on internal sensor Latch off		
MONITORING SIGNAL	Voltage on VDD pin	Voltage on FB pin	Voltage on FB pin	Voltage drop across high-side MOSFET	Sensed current in low-side MOSFET	Voltage on TSNS pin			
HIGH-SIDE MOSFET	Latch off	Latch off	Latch off	Turns off on cycle- by-cycle basis, incrementing OC counter; latch off when counter overflows	Tripping increments OC counter; latch off when counter overflows	Latch off			
LOW-SIDE MOSFET	Latch off	Latch off	Latch on until VOUT returns to within PG window	Latch off when counter overflows Counter overflow		Latch off	Latch off		
HICCUP	No	Yes ⁽¹⁾	No ⁽²⁾	Yes ⁽¹⁾	Yes ⁽¹⁾	Hiccup after temperature below reset threshold	Hiccup after temperature below reset threshold		
DURING SOFT-START	Enabled	Disabled	Enabled	Enabled	Enabled during or after SS once LDRV pulse width first exceeds CSA sampling period	Enabled	Enabled		
AFTER SOFT- START	Enabled	Enabled	Enabled	Enabled	Enabled	Enabled	Enabled		

If the device is configured to restart continuously, triggering the fault causes a hiccup.

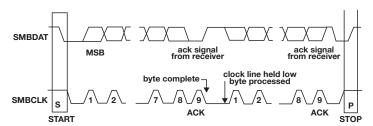
Hiccup is not triggered if the device can bring the output voltage back to regulation. Hiccup remains enabled if the output reaches the UV limit following an OV event

Table 1. Required RT

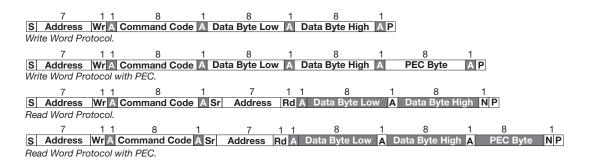
Resistors										
NOMINAL FREQUENCY (kHz)	1% RESISTOR VALUE (kΩ)									
250	10.0									
300	17.8									
400	27.4									
500	38.3									
650	56.2									
750	86.6									
850	133									
1000	205									
750 850	86.6 133									

Table 3. Required Address Resistors

Table 5.	Required Address Resistors
DIGIT	1% RESISTOR VALUE (kΩ)
0	10.0
1	17.8
2	27.4
3	38.3
4	56.2
5	86.6
6	133
7	205



Data Transfer diagram.



PMBus Command List			Green = read/write							Red :	= Read	donly		Shade = N				NVM Backup		S = sign bit	
HEX	COMMAND NAME	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0	Default	LSB Unit	Min	Max
01	OPERATION	-	-	-	-	-	-	-	-	ON	Х		Ma	rgin		х	х	00h	-	-	-
02	ON_OFF_CONFIG	-	-	-	-	-	-	-	-	х	х	х	pu	cmd	cpr	pol	сра	16h	-	-	-
03	CLEAR_FAULTS	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
10	WRITE_PROTECT	-	-	-	-	-	-	-	-	b7	b6	b5	Х	Х	х	х	х	00h	-	-	-
15	STORE_USER_ALL	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
16	RESTORE_USER_ALL	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
19	CAPABILITY	-	-	-	-	-	-	-	-	PEC	SI	PD	ALRT		Rese	rved	!	B0h	-	-	-
20	VOUT_MODE	-	-	-	-	-	-	-	-		Mode		Exponent				17h	-	-	-	
35	VIN_ON 1		E	xponent		Mantissa			, P				1antis:	sa			F011h	0.25 V	4.25 V	16V	
36	VIN_OFF ¹		Е	xpone	nt			Mar	itissa				N	Mantissa				F010h	0.25 V	4 V	15.75 V
39	IOUT_CAL_OFFSET	Ext			kponent		S Man							Mantissa				E000h	62.5 mA	-4 A	3.94 A
40	IOUT_OC_FAULT_LIMIT (C20) 2		_		•													F84Eh	0.5.4		36 A
46	IOUT_OC_FAULT_LIMIT (B20) 2	Ex		xponent		Mantissa			N				Mantissa				F834h	0.5 A	5 A	24 A	
47	IOUT_OC_FAULT_RESPONSE	-	-	-	-	-	-	-	-	Х	Х		RS		х	х	х	3Fh	-	-	-
4.0	IOUT_OC_WARN_LIMIT (C20) 2																	F8C3h	0.5.4	4.4	30 A
4A	IOUT_OC_WARN_LIMIT (B20) 2	Exponent						iviar	itissa				IV	Mantissa				F828h	0.5 A	4 A	20 A
4F	OT_FAULT_LIMIT ³	Exponent				Λ	/lantis	sa				Man	ntissa			0096h	1 C	120 C	165 C		
51	OT_WARN_LIMIT ³	Exponent				N	/lantis	sa	Mantissa								007Dh	1 C	100 C	140 C	
61	TON_RISE	Exponent				Mantissa				Mantissa							E02Bh	62.5 us	600 us	9 ms	
78	STATUS_BYTE	-	-	-	-	-				Х	OFF OV OC VIU				VIUV TMP CML NA		-	-	-	-	
79	STATUS_WORD	VF	IF	Х	MFR	PGD	Х	Х	Х	Х	OFF	OV	OC	VIUV	TMP	CML	NA	-	-	-	-
7A	STATUS_VOUT	-	-	-	-	-	-	-	-	OVF	Х	Х	UVF	х	Х	х	х	-	-	-	-
7B	STATUS_IOUT	-	-	-	-	-	-	-	-	OCF	Х	OCW	Х	х	Х	Х	Х	-	-	-	-
7D	STATUS_TEMPERATURE	-	-	-	-	-	-	-	-	OTF	OTW	Х	Х	Х	Х	Х	Х	-	-	-	-
7E	STATUS_CML	-	-	-	-	-	-	-	-	IVC	IVD	PEC	MF	х	Х	OTH	Х	-	-	-	-
80	STATUS_MFR_SPECIFIC	_		-	-	-	-	-	-	OTFI	Х	Х	IVAD	Х	Х	Х	Х	-	-	-	-
8B	READ_VOUT								Mar	ntissa								-	2 ⁻⁹ V	0 V	5.8 V
8C	READ_IOUT	Ex		xponent							Λ	/lantis	sa				-	62.5 mA	0 A	40 A	
8E	READ_TEMPERATURE_2		Е	xpone	nt						Λ	/lantis	sa					-	1 C	-40C	165C
98	PMBUS_REVISION	-	-	-	-	-	-	-	-	0	0	0	1	0	0	0	1	11h	-	-	-
D0	MS_00 (SCRATCH)	х	х	Х	х	х	х	х	х	х	х	х	х	х	х	х	х	00h	-	-	-
D4	MS_04 (VREF_TRIM)	S				N	/lantis	sa			Mantissa							0000h	2 ⁻⁹ V	-120 mV	60 mV
D5	MS_05 (STEP_VREF_MARGIN_HIGH)					N	/lantis	sa		Mantissa								001Eh	2 ⁻⁹ V	0	60 mV
D6	MS_06 (STEP_VREF_MARGIN_LOW)	S Mantissa								Mantissa								FFE2h	2-9 V	-120 mV	0
D7	MS_07 (PCT_VOUT_FAULT_PG_LIMIT)	-	-	-	-	-	-	-	-	Х	Х	х	х	Х	х	P	СТ	00h	-	-	-
D8	MS_08 (SEQUENCE_TON_TOFF_DELAY)	-	-	-	-	-	-	-	-	TO	N_DE	LAY	х	TO	FF_DE	LAY	х	00h	TON_RISE	0	7
E5	MS_21 (OPTIONS)	х	х	х	х	х	х	х	х	х	Х	х	х	х	ADC	х	х	0004h	-	-	-
E7	MS_23 (MASK_SMBALERT)	OTFI PRTC SMBT IVC IVD			PEC	MEM	ARA	OTF	OTW	OCF	OCW	OVF	UVF	PGD	VIUV	0100h	-	-	-		
	MS_44 (DEVICE_CODE) C20					D :	- 1-1 -		Cardo	•		•			andat -	- 0- 1	_	0153h	-	-	-
FC MS_44 (DEVICE_CODE) B20				Device Identifier Code								Revision Code			0143h	-	-	-			
		-		1:	VIN_ON	must b	e > VIN	_OFF	2: OCF	must b	e > OC\	N 3: O	TF must	be > O	TW						

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